

Title (en)
METHOD OF MANUFACTURING A LIGHT EMITTING ELEMENT MOUNTING BASE MEMBER, AND LIGHT EMITTING ELEMENT MOUNTING BASE MEMBER

Title (de)
VERFAHREN ZUR HERSTELLUNG EINES MONTAGESOCKELELEMENTS FÜR EIN LICHEMITTIERENDES ELEMENT, UND MONTAGESOCKELELEMENT FÜR EIN LICHEMITTIERENDES ELEMENT

Title (fr)
PROCÉDÉ DE FABRICATION D'UN ÉLÉMENT DE BASE DE MONTAGE D'ÉLÉMENT ÉLECTROLUMINESCENT, ET ÉLÉMENT DE BASE DE MONTAGE D'ÉLÉMENT ÉLECTROLUMINESCENT

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Application
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Priority
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Abstract (en)
[origin: EP3226290A1] A method of manufacturing a light emitting element mounting base member (100) includes: providing a first insulating member (18) in a plate shape having a plurality of recess portions or a plurality of through-holes (37); disposing in each recess portion or in each through-hole (37) a plurality of core members (16), each equipped with a second insulating member (14) having light reflectivity on a surface of an electrical conductor core (12); squashing upper and/or lower surfaces of the core members (16) disposed in the first insulating member (18), and disposing a light blocking resin (20) into gaps between the squashed member cores (16) by insert molding; and exposing at least one surface of each of the electrical conductor cores (12) from the second insulating members (14) by removing a part of the second insulating members (14). A light emitting element mounting base member (100) obtained by said method of manufacturing a light emitting element mounting base member (100) is also provided.

IPC 8 full level
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CPC (source: EP US)
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• US 2009095520 A1 20090416 - FUKASE KATSUYA [JP], et al
• EP 2950359 A1 20151202 - LG INNOTEK CO LTD [KR]

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